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Bib Data Sheet

CONFIRMATION NO. 3651

SERIAL NUMBER 10/693,952	FILING DATE 10/28/2003 RULE	CLASS 156	GROUP ART UNIT 1763	ATTORNEY DOCKET NO. 8017-1104
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** CONTINUING DATA *****
nae fm

** FOREIGN APPLICATIONS *****
 JAPAN 2002-312542 10/28/2002
fm

IF REQUIRED, FOREIGN FILING LICENSE GRANTED
 ** 02/06/2004

Foreign Priority claimed 35 USC 119 (a-d) conditions met	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance <i>nae fm</i> Examiner's Signature Initials	STATE OR COUNTRY JAPAN	SHEETS DRAWING 4	TOTAL CLAIMS 17	INDEPENDENT CLAIMS 2
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Verified and Acknowledged

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TITLE
 Wafer polishing method and wafer polishing apparatus in semiconductor fabrication equipment

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